

1.5A, 200V - 600V Super Fast Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Low power loss, high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- Freewheeling application

MECHANICAL DATA

- Case: SOD-123W
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.016g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I _F	1.5 A			
V _{RRM}	200 - 600 V			
I _{FSM}	40 A			
T _{J MAX}	150 °C			
Package	SOD-123W			
Configuration	Single die			





SOD-123W



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER	SYMBOL	ES15DLW	ES15GLW	ES15JLW	UNIT
Marking code on the device		ES15D	ES15G	ES15J	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	V
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	V
Forward current	I _F		1.5		А
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	40		А	
Junction temperature	T_{J}	- 55 to +150		°C	
Storage temperature	T _{STG}	- 55 to +150		°C	



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THERMAL	PERFORMANCE

PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance	R _{eJL}	26	°C/W
Junction-to-ambient thermal resistance	R _{eja}	76	°C/W
Junction-to-case thermal resistance	R _{eJC}	27	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
		$I_F = 0.75A, T_J = 25^{\circ}C$		0.80	-	V
		$I_F = 1.50A, T_J = 25^{\circ}C$	-	0.85	0.95	V
	ES15DLW	$I_F = 0.75A, T_J = 125^{\circ}C$		0.66	-	V
		$I_F = 1.50A, T_J = 125^{\circ}C$		0.73	0.80	V
		$I_F = 0.75A, T_J = 25^{\circ}C$		0.87	-	V
F (1)		$I_F = 1.50A, T_J = 25^{\circ}C$	N	0.95	1.30	V
Forward voltage ⁽¹⁾	ES15GLW	$I_F = 0.75A, T_J = 125^{\circ}C$	V _F	0.72	-	V
		$I_F = 1.50A, T_J = 125^{\circ}C$		0.80	1.05	V
		$I_F = 0.75A, T_J = 25^{\circ}C$		1.06	-	V
		$I_F = 1.50A, T_J = 25^{\circ}C$		1.18	1.70	V
	ES15JLW	$I_F = 0.75A, T_J = 125^{\circ}C$		0.84	-	V
		$I_F = 1.50A, T_J = 125^{\circ}C$		0.97	1.30	V
Reverse current @ rated V _R ⁽²⁾		$T_J = 25^{\circ}C$	I _R	-	1	μA
		T _J = 125°C		-	150	μA
	ES15DLW	1MHz, V _R = 4.0V	CJ	24	-	pF
Junction capacitance	ES15GLW			21	-	pF
	ES15JLW			20	-	pF
Reverse recovery time		I _F = 0.5A , I _R = 1.0A I _{rr} = 0.25A	t _{rr}	-	35	ns

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾ PACKAGE PACKING			
ES15xLW	SOD-123W	10,000 / Tape & Reel	

Notes:

1. "x" defines voltage from 200V(ES15DLW) to 600V(ES15JLW)



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

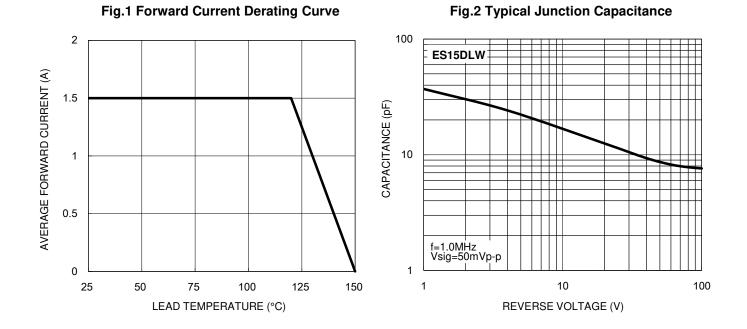
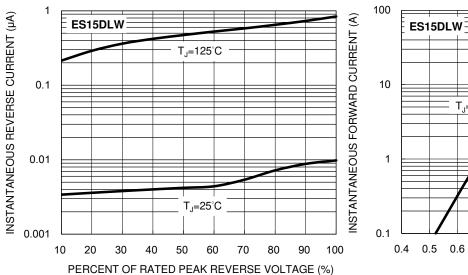
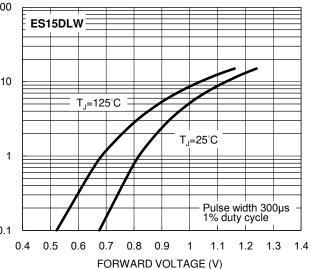


Fig.3 Typical Reverse Characteristics

Fig.4 Typical Forward Characteristics



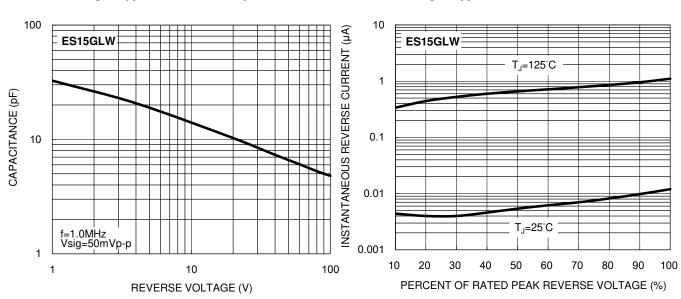




CHARACTERISTICS CURVES

Fig.5 Typical Junction Capacitance

(T_A = 25°C unless otherwise noted)



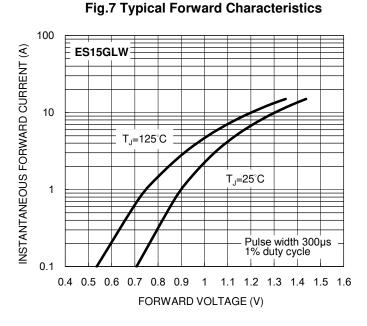
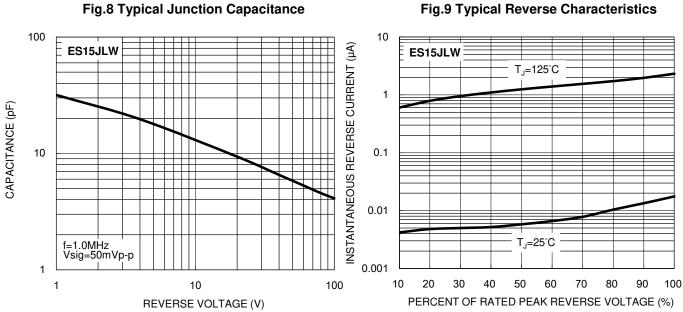


Fig.6 Typical Reverse Characteristics



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$



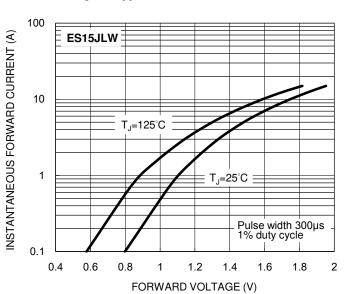
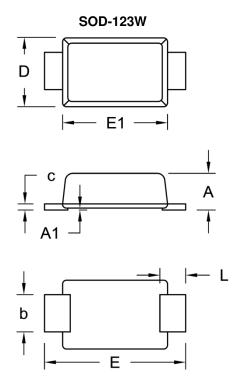


Fig.10 Typical Forward Characteristics

Fig.9 Typical Reverse Characteristics

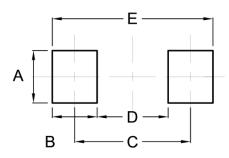
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PACKAGE OUTLINE DIMENSIONS



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	0.90	1.02	0.035	0.040
A1	0.00	0.10	0.000	0.004
b	0.90	1.05	0.035	0.041
с	0.10	0.22	0.004	0.009
D	1.70	1.90	0.067	0.075
E	3.60	3.80	0.142	0.150
E1	2.60	2.90	0.102	0.114
L	0.50	0.85	0.020	0.033

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.40	0.055
В	1.20	0.047
С	3.10	0.122
D	1.90	0.075
E	4.30	0.169

MARKING DIAGRAM



P/N = Marking Code

YW = Date Code

F = Factory Code



ES15DLW – ES15JLW

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